GP1S092HCPI

Subminiature, Surface Mount Type Photointerrupter

■ Features

1. Subminiature, transmissive type (4.5×2.6×2.9mm)
2. Surface mount type
3. Wide gap (Gap width : 2mm)
4. Slit width (Detector side) : 0.3mm
5. Tape-packaged product

■ Applications

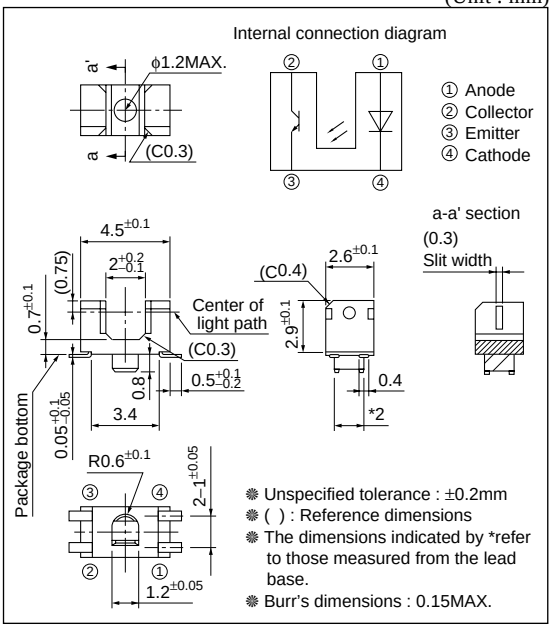
1. Cameras
2. CD-ROM drives
3. VCR

■ Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	Reverse voltage	V_R	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	20	mA
	Collector power dissipation	P_C	75	mW
Total power dissipation		P_{tot}	100	mW
Operating temperature		T_{opr}	−25 to +85	°C
Storage temperature		T_{stg}	−40 to +100	°C
*1 Soldering temperature		T_{sol}	260	°C

*1 For MAX. 5s

■ Outline Dimensions (Unit : mm)



■ Electro-optical Characteristics

(Ta=25°C)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		V_F	I_F=20mA	–	1.2	1.4	V
	Reverse current		I_R	V_R=3V	–	–	10	μA
Output	Collector dark current		I_{CEO}	V_{CE}=20V	–	–	100	nA
Transfer characteristics	Collector current		I_C	V_{CE}=5V, I_F=5mA	100	–	400	μA
	Collector-emitter saturation voltage		$V_{CE(sat)}$	I_F=10mA, I_C=40μA	–	–	0.4	V
	Response time	Rise time	t_r	V_{CE}=5V, I_C=100μA	–	50	150	μs
		Fall time	t_f	R_L=1 000Ω	–	50	150	μs

Fig.1 Forward Current vs. Ambient Temperature

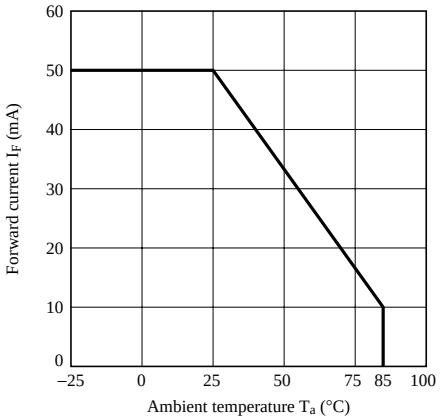


Fig.2 Power Dissipation vs. Ambient Temperature

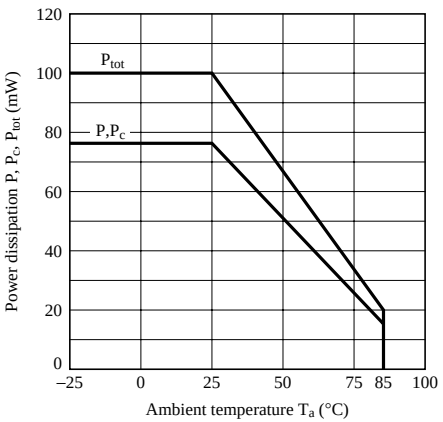


Fig.3 Forward Current vs. Forward Voltage

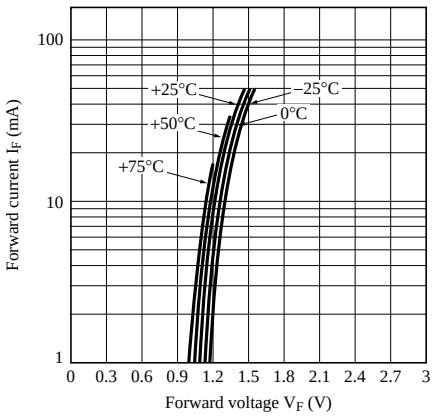


Fig.4 Collector Current vs. Forward Current

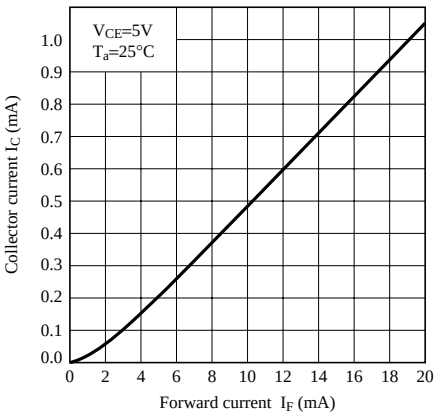


Fig.5 Collector Current vs. Collector-emitter Voltage

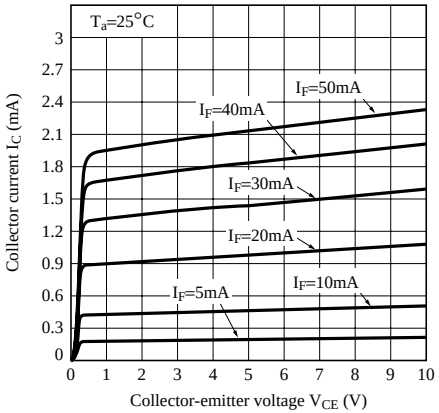


Fig.6 Relative Collector Current vs. Ambient Temperature

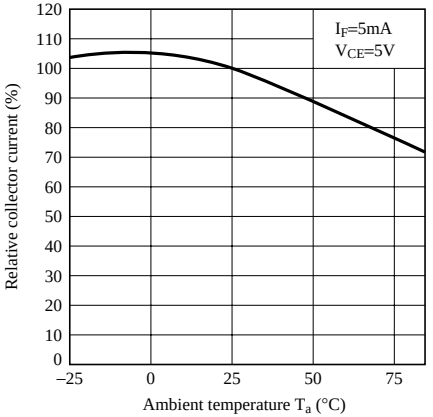


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

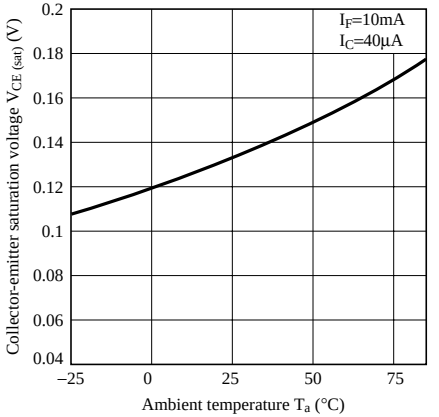


Fig.8 Collector Dark Current vs. Ambient Temperature

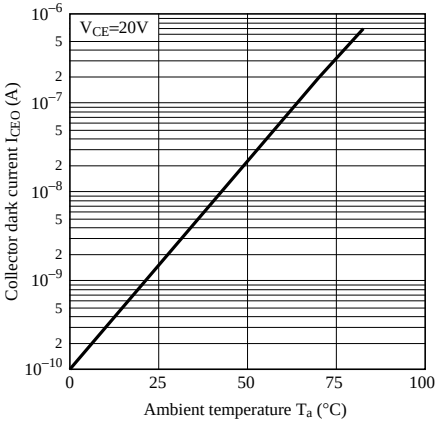


Fig.9 Response Time vs. Load Resistance

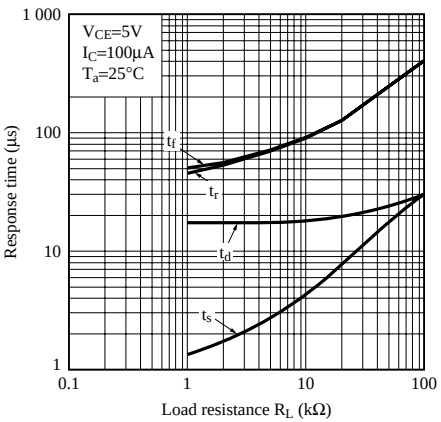


Fig.10 Test Circuit for Response Time

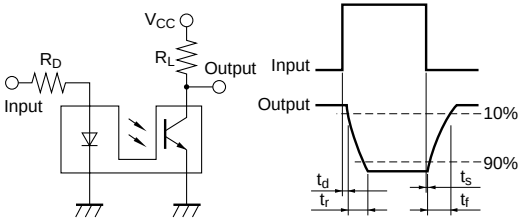


Fig.11 Relative Collector Current vs. Shield Distance (1)

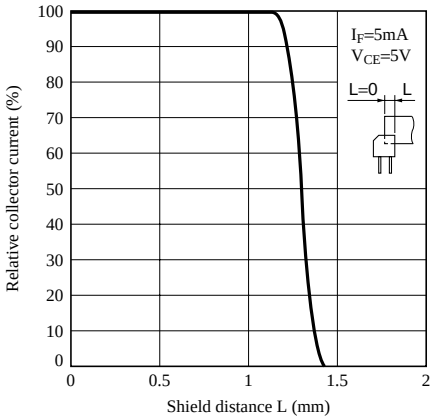
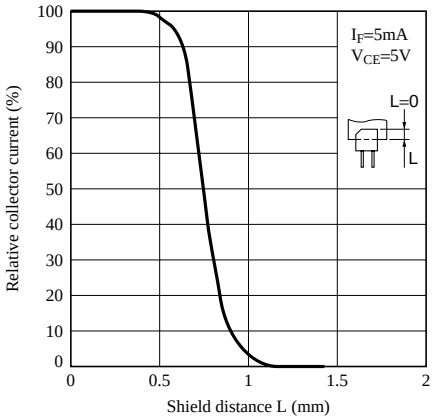


Fig.12 Relative Collector Current vs. Shield Distance (2)



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